

()	Preliminary Specifications
1	√ 1	Final Specifications

Module	15.6" (15.55) FHD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B156HTN01.1 (H/W:0A)
Note (🗭)	R,G phosphor LED Backlight with driving circuit design

Customer	Date	Approved by	Date
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Note: This Specification is su without notice.	bject to change	NBBU Marketi AU Optronics	ing Division / s corporation



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Record of Revision

Vers	sion and Date	Page	Old description	New Description	Remark
0.1	2012/11/29	All	Preliminary Edition for Customer		
1.0	2013/01/28	All		Final Edition for Customer	
1.1	2013/02/01	All		Final Edition updated for Customer	
1.2		19 of 32;23 of 32		Update Mechanical Characteristics	
1.3	2013/05/27	page 28~3 1		Update EDID(Check Sum:81)	

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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electros tic breakdown.



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2. General Description

B156HTN01.1 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 FHD (1920(H) x 1080(V)) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B156HTN01.1 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit		Speci	fications			
Screen Diagonal	[mm]	15.6" (15.55)					
Active Area	[mm]	344.16 x 193.59					
Pixels H x V		1920x3(RGB)	1920x3(RGB) x 1080				
Pixel Pitch	[mm]	0.17925 x 0.1	7925				
Pixel Format		R.G.B. Vertic	al Stripe				
Display Mode		Normally Wh	nite				
White Luminance (ILED=30mA) (Note: ILED is LED current)	[cd/m ²]	, , , ,	oints averag	,			
Luminance Uniformity		1.25 max. (5	points)				
Contrast Ratio		400 :1					
Response Time	[ms]	8 typ / 16 Max					
Nominal Input Voltage VDD	[Volt]	+3.3 typ.					
Power Consumption	[Watt]	11.0 max. (Include Logic and Blu power)					
Weight	[Grams]	475 max.					
Physical Size	[mm]		Min.	Тур.	Max.		
Without inverter, bracket.		Length	358.8	359.3	359.8		
		Width	209.0	209.5	210.0		
		Thickness	-	-	5.8		
Electrical Interface		2 channel L\	/DS				
Glass Thickness	[mm]	0.5					
Surface Treatment			lardness 2H,H pe=normal,	aze=42%±7 Reflection≤3%	%		
Support Color		262K colors (RGB 6-bit)					
Temperature Range Operating Storage (Non-Operating)	[°C]	0 to +50 -20 to +60					
RoHS Compliance		RoHS Comp	liance				



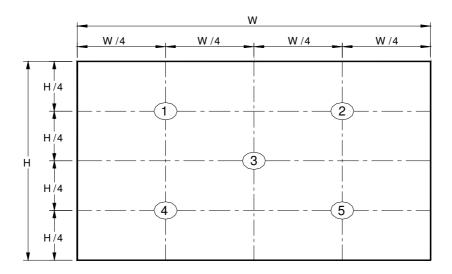
2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

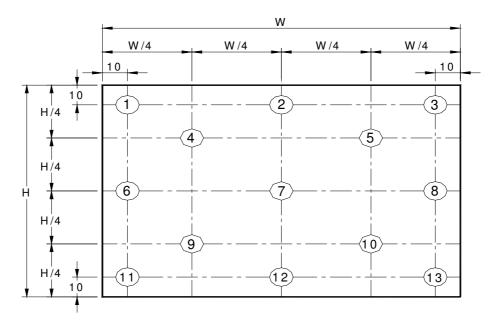
Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Luminance ILED=30mA			5 points average	230	270	ı	cd/m²	1, 4, 5.
Viewing Angle		Θ_{R}	Horizontal (Right)	60	70	-	degre	
		θL	CR = 10 (Left)	60	70	1	е	4 0
		Ψн	Vertical (Upper)	45	60	-		4, 9
		Ψι	CR = 10 (Lower)	50	60	ı		
Luminance Uniformity		δ_{5P}	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		δ _{13P}	13 Points	-	-	1.50		2, 3, 4
Contrast Ratio		CR		300	400	-		4, 6
Cross talk		%				4		4, 7
Response Time		T _{RT}	Rising + Falling	-	8	16	msec	4, 8
	Red Rx Ry		0.646	0.676	0.706			
		Ry		0.283	0.313	0.343		
	Green	Gx		0.187	0.217	0.247		
Color /	Green	Gy		0.631	0.661	0.691		
Chromaticity Coodinates		Bx	CIE 1931	0.112	0.142	0.172		4
	Blue	Ву		0.037	0.067	0.097	-	
		Wx		0.283	0.313	0.343		
	White	Wy		0.299	0.329	0.359		
NTSC		%			95			

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Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

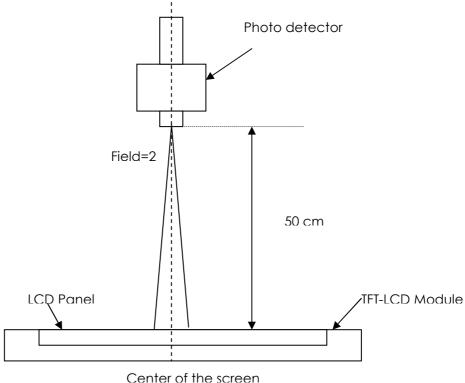
δw5 =		Maximum Brightness of five points
δw5 =	= -	Minimum Brightness of five points
2	_	Maximum Brightness of thirteen points
δ w13 =	=	Minimum Brightness of thirteen points

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after



lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Contrast ratio (CR)=
$$\frac{\text{Brightness on the "White" state}}{\text{Brightness on the "Black" state}}$$

Note 7: Definition of Cross Talk (CT)

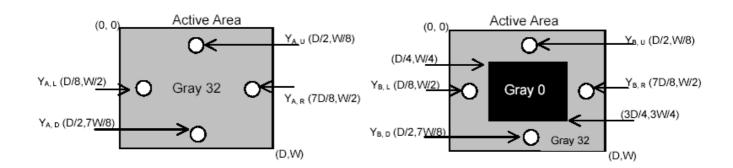
$$CT = | Y_B - Y_A | / Y_A \times 100 (\%)$$

Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

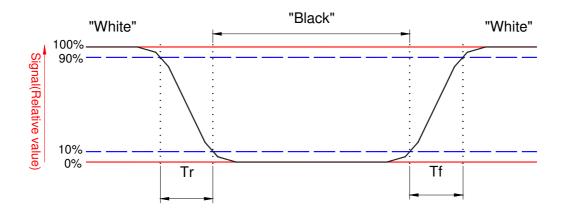
 $Y_B =$ Luminance of measured location with gray level 0 pattern (cd/m₂)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

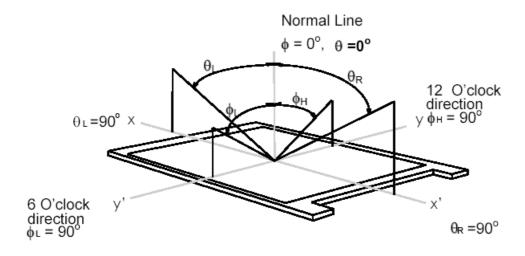




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Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.

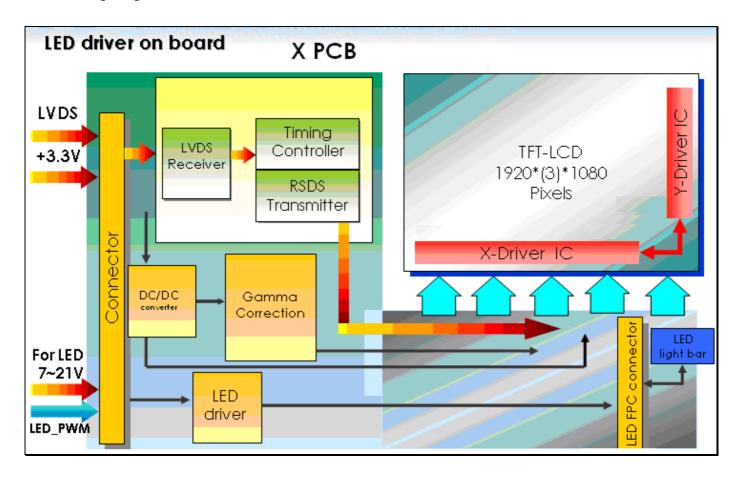


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3. Functional Block Diagram

The following diagram shows the functional block of the 15.6 inches wide Color TFT/LCD 40 Pin.



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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

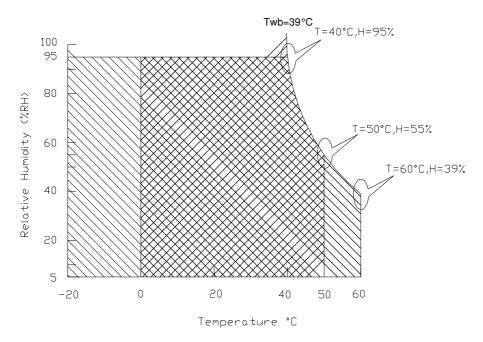
ltem	Symbol	Min	Max	Unit	Conditions				
Operating	TOP	0	+50	[°C]	Note 4				
Operation Humidity	HOP	5	95	[%RH]	Note 4				
Storage Temperature	TST	-20	+60	[°C]	Note 4				
Storage Humidity	HST	5	95	[%RH]	Note 4				

Note 1: At Ta (25° C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+



5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as follows;

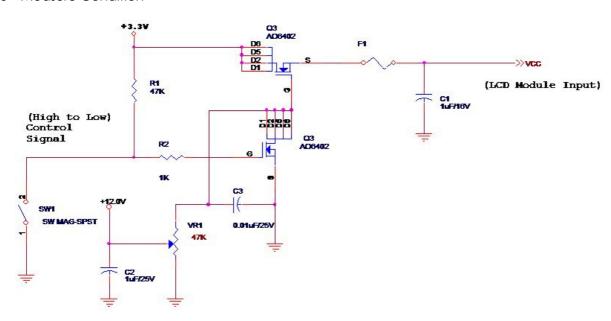
The power specification are measured under 25°C and frame frenquency under 60Hz

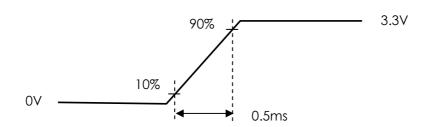
Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	2.0	[Watt]	Note 1/2
IDD	IDD Current	=	-	606	[mA]	Note 1/2
IRush	Inrush Current	-	-	2000	[mA]	Note 3
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern at 3.3V driving voltage. (Pmax=V3.3 x lblack)

Note 2: Typical Measurement Condition: Mosaic Pattern

Note 3: Measure Condition







5.1.2 Signal Electrical Characteristics

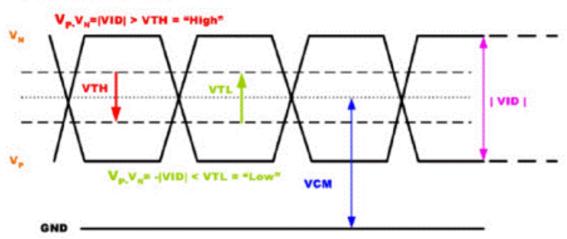
Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V _{тн}	Differential Input High Threshold (Vcm=+1.2V)	-	100	[mV]
V _{TL}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{ID}	Differential Input Voltage	100	600	[mV]
VcM	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform







5.2 Backlight Unit

5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power	PLED	-	9.0	9.6	[Watt]	(Ta=25°C), Note 1
Consumption						Vin =12V
LED Life-Time	N/A	10,000	-	-	Hour	(Ta=25 $^{\circ}$ C), Note 2
						I _F =30 mA

Note 1: Calculator value for reference PLED = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	7.0	12.0	21.0	[Volt]	
LED Enable Input High Level	VLED_EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level	, v.E.B_ETT	-	-	0.8	[Volt]	
PWM Logic Input High Level	VPWM EN	2.5	-	5.5	[Volt]	Define as Connector
PWM Logic Input Low Level		-	-	0.8	[Volt]	Interface (Ta=25°C)
PWM Input Frequency	FPWM	100	200	20k	Hz	
PWM Duty Ratio	Duty	1 *Note 2		100	%	

Note 1: Recommanded system pull up/down resistor no bigger than 10kohm.

Note 2: If the PWM duty ratio (min) is set between 5% to 1%, the PWM input frequency should be set below 1KHz. The brightness-duty characteristic might not be able to keep in it's linearity if the dimming control is operated in 1% to 5% range.



6. Signal Characteristic

6.1 Pixel Format Image

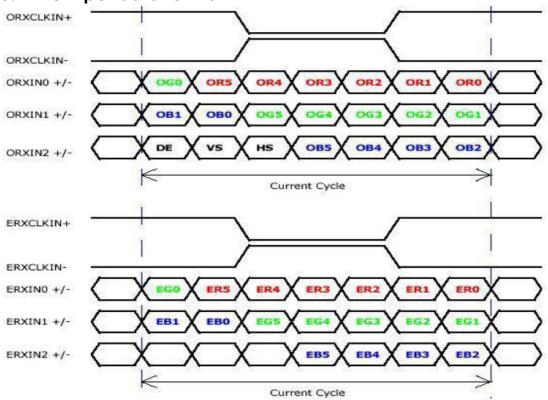
Following figure shows the relationship of the input signals and LCD pixel format.

		1																			19	20)
1st Line	R	G	В	R	G	В			-		-			-	-		F	2	G	В	R	G	В
												1 1							1 .			1	
												1 1							i .			1	
		•										1											
					1							1 1							1			· ·	
	_		_	_		_												Ţ		٥)		
1080th Line	R	G	В	R	G	R	-	•	-	· -		_	-		· •	-		?	G	В	R	G	В



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6.2 The input data format



Signal Name	Description	
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of these 6 bits pixel data.
R3	Red Data 3	
R2	Red Data 2	
R1	Red Data 1	
RO	Red Data 0 (LSB)	
	Red-pixel Data	
	ked-pixei Dala	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of these 6 bits pixel
G3	Green Data 3	data.
G2	Green Data 2	
G1	Green Data 1	
G0	Green Data 0 (LSB)	
	Croon pivol Data	
B5	Green-pixel Data	Diversive Device
B4	Blue Data 5 (MSB) Blue Data 4	Blue-pixel Data Each blue pixel's brightness data consists of these 6 bits pixel data.
B3	Blue Data 3	Lactible pixers brightness adia consists of these oblis pixer adia.
B2	Blue Data 2	
B1	Blue Data 1	
BO	Blue Data 0 (LSB)	
	2.00 2 3.00 (202)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and DE signals. All pixel
		data shall be valid at the falling edge when the DE signal is high
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel data shall be valid to
		be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN .
HS	Horizontal Sync	The signal is synchronized to RxCLKIN .

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Integration Interface and Pin Assignment

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX
Type / Part Number	IPEX 20455-040E-#2
Mating Housing/Part Number	IPEX 20353-040T-##

Type / Part Number: #: 0: with datum mark, 1: without datum mark

Mating Housing/Part Number: 1st # (shell-A P/N): 0: with datum mark, 1: without datum mark;

2nd #: 1: with pull bar, 2: without pull bar

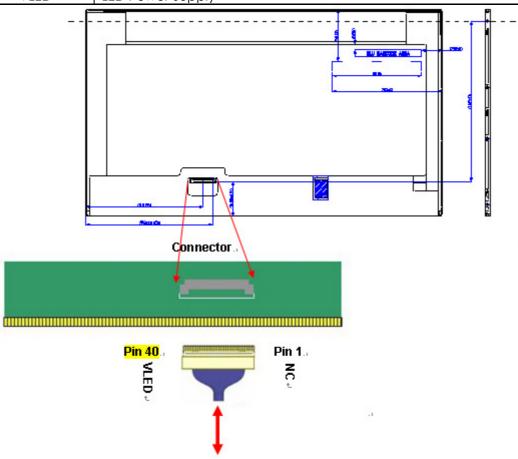
6.3.2 Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device

PIN#	Signal Name	Description
1	NC	No Connection (Reserve)
2	AVDD	Power Supply +3.3V
3	AVDD	Power Supply +3.3V
4	DVDD	DDC 3.3Vpower
5	NC	No Connection (Reserve)
6	SCL	DDCClock
7	SDA	DDCData
8	Odd_Rin0-	-LVDS differential data input(R0-R5,G0)
9	Odd_Rin0+	+LVDS differential data input(R0-R5,G0)
10	GND	Ground
11	Odd_Rin1-	-LVDS differential data input(G1-G5,B0-B1)
12	Odd_Rin1+	+LVDS differential data input(G1-G5,B0-B1)
13	GND	Ground
14	Odd_Rin2-	-LVDS differential data input(B2-B5,HS,VS,DE)
15	Odd_Rin2+	+LVDS differential data input(B2-B5,HS,VS,DE)
16	GND	Ground
17	Odd_ClkIN	-LVDS differential clock input
18	Odd_ClkIN+	+LVDS differential clock input
19	GND	Ground
20	Even_Rin0-	-LVDS differential data input(R0-R5,G0)
21	Even_Rin0+	+LVDS differential data input(R0-R5,G0)
22	GND	Ground



23	Even_Rin1-	-LVDS differential data input(G1-G5,B0-B1)
24	Even_Rin1+	+LVDS differential data input(G1-G5,B0-B1)
25	GND	Ground
26	Even_Rin2-	-LVDS differential data input(B2-B5,HS,VS,DE)
27	Even_Rin2+	+LVDS differential data input(B2-B5,HS,VS,DE)
28	GND	Ground
29	Even_ClkIN-	-LVDS differential clock input
30	Even_ClkIN+	+LVDS differential clock input
31	GND	Ground-Shield
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection (Reserve)
35	PWM	System PWM Logic Input level
36	LED_EN	LED enable input level
37	NC	No Connection (Reserve)
38	VLED	LED Power Supply
39	VLED	LED Power Supply
40	VLED	LED Power Supply



Note1: Input signals shall be low or High-impedance state when VDD is off.

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6.4 Interface Timing

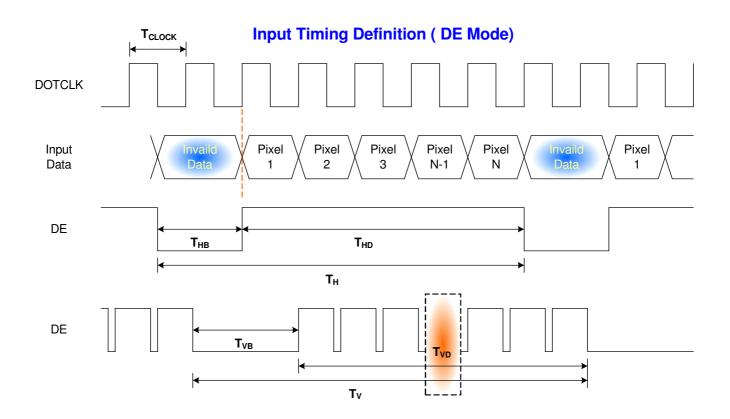
6.4.1 Timing Characteristics

Basically, interface timings should match the 1920x1080 /60Hz manufacturing guide line timing.

Parar	neter	Symbol	Min.	Тур.	Max.	Unit
Frame	e Rate	-	40 60		-	Hz
Clock fre	equency	1/T _{Clock}	1	71.19	85	MHz
	Period	T _V	1088	1130	•	
Vertical	Active	T _{VD}		1080		T Line
Section	Blanking	T ∨B	8	50	-	
	Period	T _H	990	1050	-	
Horizontal	Active	T HD		960		T Clock
Section	Blanking	T HB	30	90	-	

Note: DE mode only

6.4.2 Timing diagram

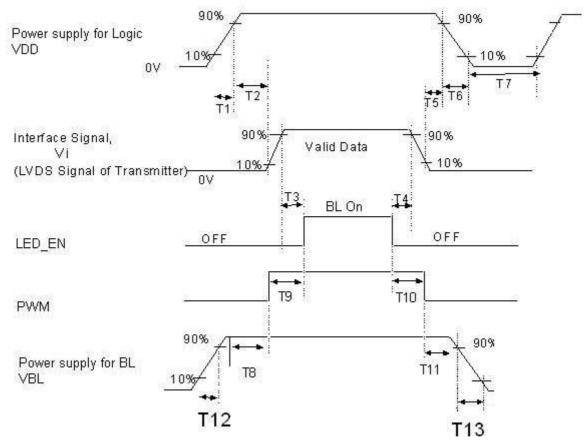




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6.5 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



	Pow	er Sequence Tir	ming	
		Value		
Parameter	Min.	Тур.	Max.	Units
TI	0.5	-	10	
T2	0	-	50	
T3	200	-	-	
T4	0	-	-	
T5	0	-	-	
T6	0	-	10	
T 7	150	-	-	ms
T8	0	-	-	
T 9	0	-	-	
T10	0	-	-	
TII	0	-	-	
T12	0.2	-	-	
T13	0	-	-	

Note: If T4<200ms, the display garbage may occur. We suggest T4>200ms to avoid the display garbage. Note: If T1 or T12<0.5, the inrush curren may cause the damage of fuse If the T1 or T12<0.5, the inrush current I2t is under typical melt of fuse Spec. there's no above-mentioned problem. Note: If T3, T5, T6 couldn't match above specifications, must request T3+T5+T6 > 200ms at least

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7. Vibration and Shock Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

• Frequency: 10 - 500Hz Random

30 Minutes each Axis (X, Y, Z) Sweep:

7.2 Shock Test Spec:

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X.Y.Z. one time for each side

7.3. Reliability

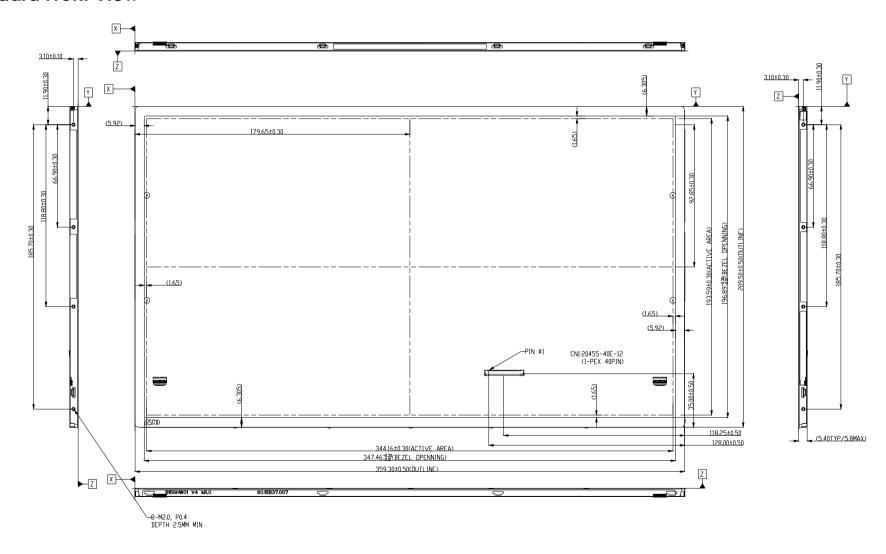
Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40°C, 90%RH, 300h	
High Temperature Operation	Ta= 50°C, Dry, 300h	
Low Temperature Operation	Ta= 0°C, 300h	
High Temperature Storage	Ta= 60°C , 35%RH, 300h	
Low Temperature Storage	Ta= -20°C , 50%RH, 250h	
Thermal Shock Test	Ta=-20°C to 60°C, Duration at 30 min, 100 cycles	
ESD	Contact: ±8 KV Air: ±15 KV	Note 1

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. Self-recoverable. No data lost, No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



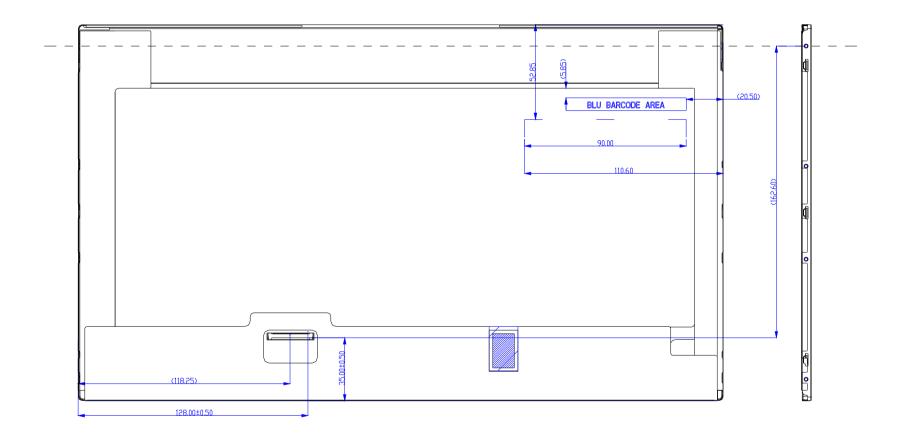
- 8. Mechanical Characteristics
- 8.1 LCM Outline Dimension
- 8.1.1 Standard Front View





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8.1.2 Standard Rear View



Note: Prevention IC damage, IC positions not allowed any overlap over these areas.

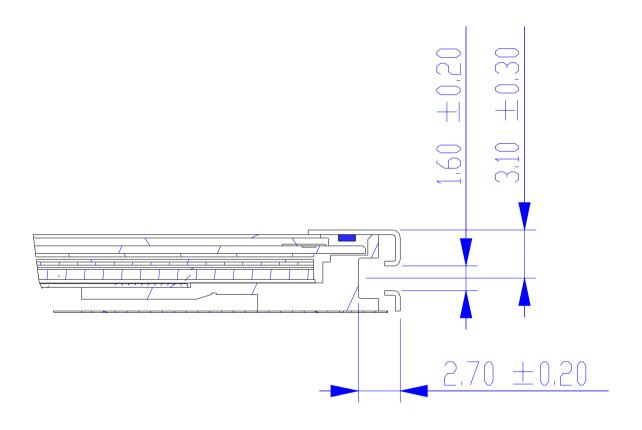
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AU OPTRONICS CORPORATION

8.1.3 Screw Hole Depth and Center Position

Maximum Screw penetration from side surface is 2.7 ± 0.2 mm (See drawing) Screw hole center location, from front surface = 3.10 ± 0.3 mm (See drawing) Screw Torque: Maximum 2.5 kgf-cm





9. Shipping and Package

9.1 Shipping Label Format



Manufactured MM/WW Model No: B156HTN01.1

AU Optronics MADE IN China (\$01)

HW: 0A FW:1

C 队 US E204356

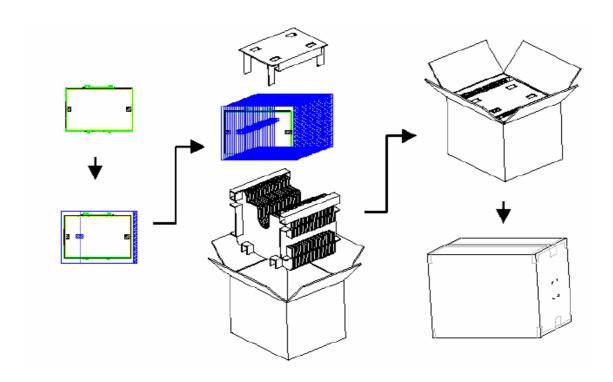




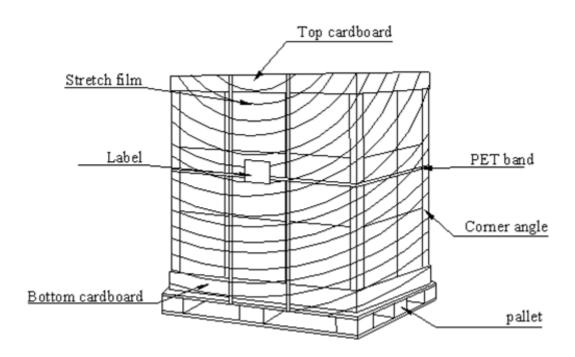




9.2. Carton package



9.3 Shipping package of palletizing sequence



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10. Appendix: EDID description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	0000000	0	
01	1,000	FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	0000000	0	
08	EISA Manuf. Code LSB	06	0000011	6	
09	Compressed ASCII	AF	1010111	175	
			1110110		
0A	Product Code	ED	0001000	237	
0B	hex, LSB first	11	0000000	17	
0C	32-bit ser #	00	0000000	0	Color Engine Setting
0D		00	0000000	0	
0E		00	0000000	0	
0F		00	0 0000000	0	
10	Week of manufacture	00	0000000	0	
11	Year of manufacture	16	0	22	
12	EDID Structure Ver.	01	0000000	1	
13	EDID revision #	04	0000010 0	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	90	1001000	144	
15	Max H image size (rounded to cm)	22	0010001 0	34	
16	Max V image size (rounded to cm)	13	0001001	19	
17	Display Gamma (=(gamma*100)-100)	78	0111100 0	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	02	0000001	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	21	0010000	33	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	35	0011010	53	
1B	Red x (Upper 8 bits)	AD	1010110	173	
1C	Red y/ highER 8 bits	50	0101000 0	80	
1D	Green x	37	0011011	55	
1E	Green y	AA	1010101	170	
1F	Blue x	24	0010010	36	



		l	0001000		1
20	Blue y	11	0101000	17	
21	White x	50	0101010	80	
22	White y	54	0000000	84	
23	Established timing 1	00	0	0	
24	Established timing 2	00	0000000	0	<u>—</u>
25	Established timing 3	00	0000000	0	
26	Standard timing #1	01	0000000	1	
27		01	0000000	1	
	Other depart time in a #0		0000000		
28	Standard timing #2	01	0000000	1	
29		01	0000000	1	
2A	Standard timing #3	01	1 0000000	1	
2B		01	1 0000000	1	
2C	Standard timing #4	01	1	1	
2D		01	0000000	1	
2E	Standard timing #5	01	0000000	1	
2F		01	0000000	1	
30	Standard timing #6	01	0000000	1	
	Standard tilling #0		0000000		
31		01	0000000	1	
32	Standard timing #7	01	0000000	1	
33		01	1 0000000	1	
34	Standard timing #8	01	1	1	
35		01	0000000	1	
36	Pixel Clock/10000 LSB	7C	0111110	124	
37	Pixel Clock/10000 USB	38	0011100	56	
38	Horz active Lower 8bits	80	1000000	128	
39	Horz blanking Lower 8bits		1101010		
		D4	0 0111000	212	
3A	HorzAct:HorzBlnk Upper 4:4 bits Vertical Active Lower 8bits	70	0 0011100	112	
3B		38	0 0011001	56	
3C	Vertical Blanking Lower 8bits	32	0 0100000	50	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	40	0	64	
3E	HorzSync. Offset	3C	0	60	
3F	HorzSync.Width	30	0011000	48	
40	VertSync.Offset : VertSync.Width	AA	1010101 0	170	
41	Horz‖ Sync Offset/Width Upper 2bits	00	0000000	0	
	Horizontal Image Size Lower 8bits		0101100		
42		58	0	88	



43	Vertical Image Size Lower 8bits	C1	1100000	193	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	0001000	16	
45	Horizontal Border (zero for internal LCD)	00	0000000	0	
46	Vertical Border (zero for internal LCD)	00	0000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	0001100	24	
48	Detailed timing/monitor	7C	0111110	124	
49	descriptor #2	38	0011100	56	
4A		80	1000000	128	
4B		7E	0111111	126	
4C		72	0111001 0	114	
4D		38	0011100 0	56	
4E		32	0011001 0	50	
4F		40	0100000 0	64	
50		3C	0011110	60	
51		30	0011000	48	
52		AA	1010101 0	170	
53		00	0000000	0	
54		58	0101100 0	88	
55		C1	1100000 1	193	
56		10	0001000 0	16	
57		00	0000000	0	
58		00	0000000	0	
59		18	0001100 0	24	
5A	Detailed timing/monitor	00	0000000	0	
5B	descriptor #3	00	0000000	0	
5C		00	0000000	0	
5D		FE	1111111	254	
5E		00	0000000	0	
5F	Manufacture	41	0100000	65	A
60	Manufacture	55	0101010 1 0100111	85	U
61	Manufacture	4F	0100111	79	0
62		0A	0000101	10	
63		20	0010000	32	
64		20	0010000	32	
65		20	0010000	32	



	Ad of Thomos dol	0	•		
66		20	0010000	32	
			0010000		
67		20	0	32	
			0010000		
68		20	0	32	
CO		00	0010000	00	
69		20	0010000	32	
6A		20	0010000	32	
			0010000		
6B		20	0	32	
			0000000		
6C	Detailed timing/monitor	00	0	0	
CD.	de e estado a UA	00	0000000	0	
6D	descriptor #4	00	0000000	0	
6E		00	0	0	
<u> </u>		- 00	1111111		
6F		FE	0	254	
			0000000		
70		00	0	0	
	M (4.0	0100001		
71	Manufacture P/N	42	0	66	В
72	Manufacture P/N	31	0011000	49	4
12	Manufacture F/IV	31	0011010	43	l l
73	Manufacture P/N	35	1	53	5
			0011011		_
74	Manufacture P/N	36	0	54	6
			0100100		
75	Manufacture P/N	48	0	72	Н
76	Manufacture P/N	54	0101010 0	84	Т
70	Manuacture F/N	34	0100111	04	l l
77	Manufacture P/N	4E	0	78	N
			0011000		
78	Manufacture P/N	30	0	48	0
			0011000		
79	Manufacture P/N	31	1 0010111	49	1
7A	Manufacture P/N	2E	0010111	46	
/A	ivialiuidulue F/IV		0011000	40	•
7B	Manufacture P/N	31	1	49	1
			0010000		-
7C		20	0	32	
			0000101		
7D		0A	0	10	
75	Extension Flor	00	0000000	0	
7E	Extension Flag	00	1000000	0	
7F	Checksum	81	1	129	
	Shooksani	1 01	. '	120	1